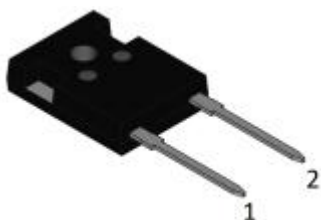


## S5D50170H2 1700V SIC POWER SCHOTTKY RECTIFIER



TO-247AC(TO-247-2)

### Description

This 1700V 50A diode is high voltage Schottky rectifier that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S5D50170H2 is ideal for energy sensitive, high frequency applications in challenging environments.

### Circuit Diagram



### Features

- 175°C T<sub>J</sub> operation
- Ultra-low switching loss
- Switching speeds independent of operating temperature
- Low total conduction losses
- High forward surge current capability
- High package isolation voltage
- “-A” is an AEC-Q101 qualified device
- Terminals finish: 100% Pure Tin
- Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional electrical and life testing can be performed upon request

### Applications

- Alternative energy inverters
- Power Factor Correction (PFC)
- Free-Wheeling diodes
- Switching supply output rectification
- Reverse polarity protection

## Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	-	1700	V
Average Rectified Forward Current	$I_F (AV)1$	$T_c=25^{\circ}C$	200	A
	$I_F (AV)2$	$T_c=160^{\circ}C$	50	A
Peak One Cycle Non-Repetitive Surge Current	$I_{FSM1}$	10ms, Half Sine pulse, $T_c=25^{\circ}C$	560	A
	$I_{FSM2}$	10ms, Half Sine pulse, $T_c=110^{\circ}C$	420	A
Repetitive Peak Forward Surge Current	$I_{FRM1}$	10 ms, Half Sine pulse, $T_c=25^{\circ}C$	320	A
	$I_{FRM2}$	10 ms, Half Sine pulse, $T_c=110^{\circ}C$	240	A
Power Dissipation	$P_{tot1}$	$T_c=25^{\circ}C$	750	W
	$P_{tot2}$	$T_c=110^{\circ}C$	325	W

## Electrical Characteristics:

Characteristics	Symbol	Condition	Typ.	Max.	Units
Forward Voltage Drop*	$V_{F1}$	@ 50A, Pulse, $T_J = 25^{\circ}C$	1.55	1.8	V
	$V_{F2}$	@ 50A, Pulse, $T_J = 175^{\circ}C$	2.5	3.0	V
Reverse Current*	$I_{R1}$	@ $V_R$ = rated $V_R$ , $T_J = 25^{\circ}C$	2	20	uA
	$I_{R2}$	@ $V_R$ = rated $V_R$ , $T_J = 175^{\circ}C$	40	400	uA
Junction Capacitance	$C_{T1}$	$V_R=0V$ , $f=1MHz$ , $T_J=25^{\circ}C$ ,	4800	-	pF
	$C_{T2}$	$V_R=1700V$ , $f=1MHz$ , $T_J=25^{\circ}C$ ,	209	-	pF
Reverse Recovery Charge	$Q_c$	$I_F = 50A$ , $di/dt = 200A/\mu s$ $V_R = 1700V$ , $T_J = 25^{\circ}C$	567	-	nC
Capacitance Stored Energy	$E_c$	$V_R = 1700V$ , $T_J = 25^{\circ}C$	615	-	$\mu J$

\* Pulse width < 300  $\mu s$ , duty cycle < 2%

## Thermal-Mechanical Specifications:

Characteristics	Symbol	S5D50170H2	Units
Junction Temperature	$T_J$	-55 to +175	$^{\circ}C$
Storage Temperature	$T_{stg}$	-55 to +175	$^{\circ}C$
Typical Thermal Resistance Junction to Case	$R_{\theta JC}$	0.2	$^{\circ}C/W$

## Ordering Information

Device	Package	Plating	Shipping
S5D50170H2	TO-247AC(TO-247-2)	Pure Sn	25pcs / tube

## Ratings and Characteristics Curves

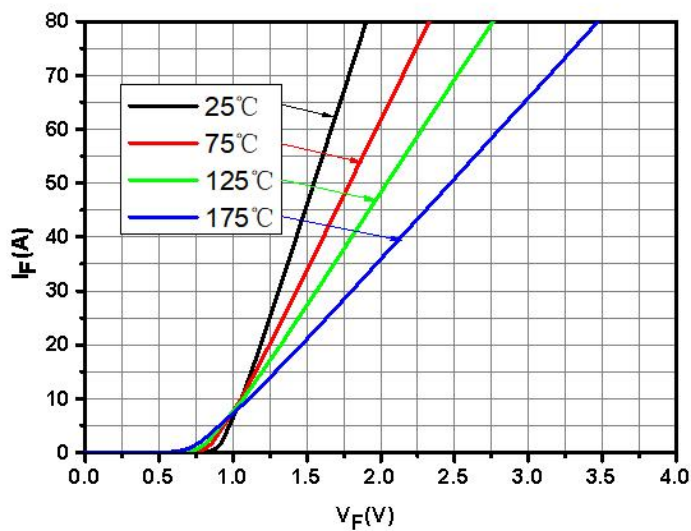


Fig.1-Typical Forward Voltage Characteristics

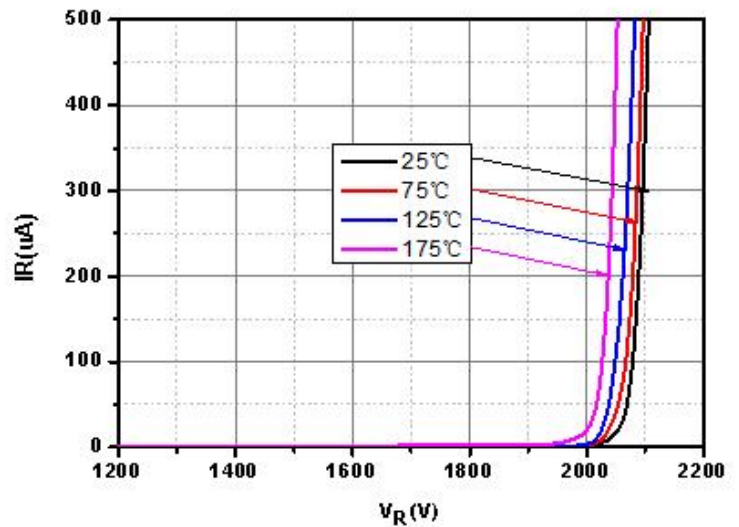


Fig.2-Typical Reverse Characteristics

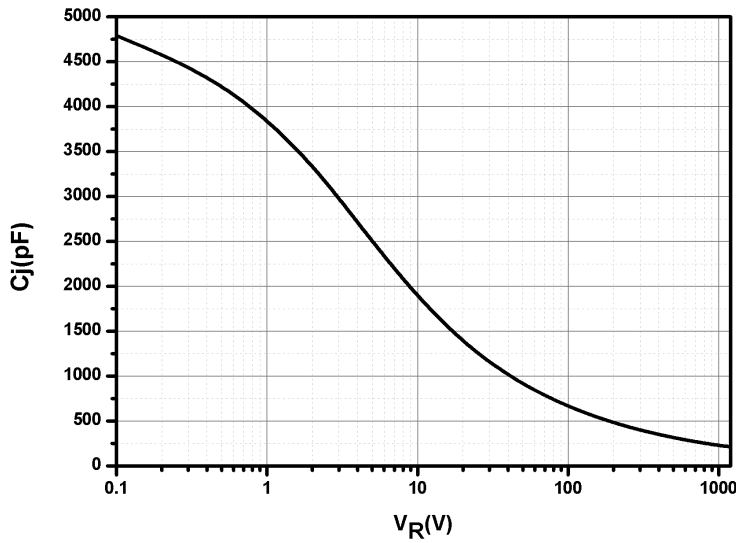


Fig.3-Capacitance vs. Reverse Voltage

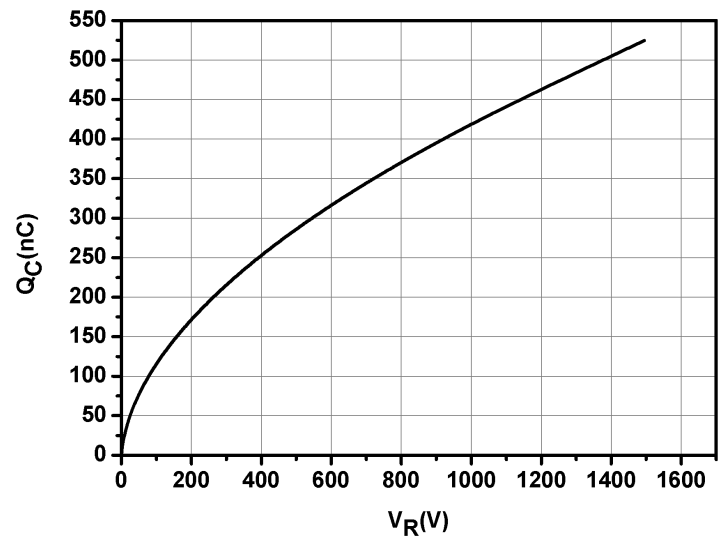


Fig.4-Total Capacitance Charge vs. Reverse Voltage

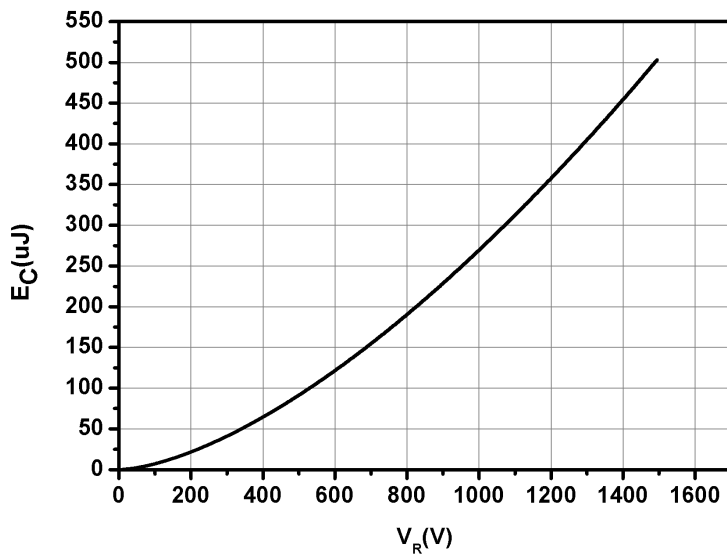


Fig.5-Capacitance Stored Energy

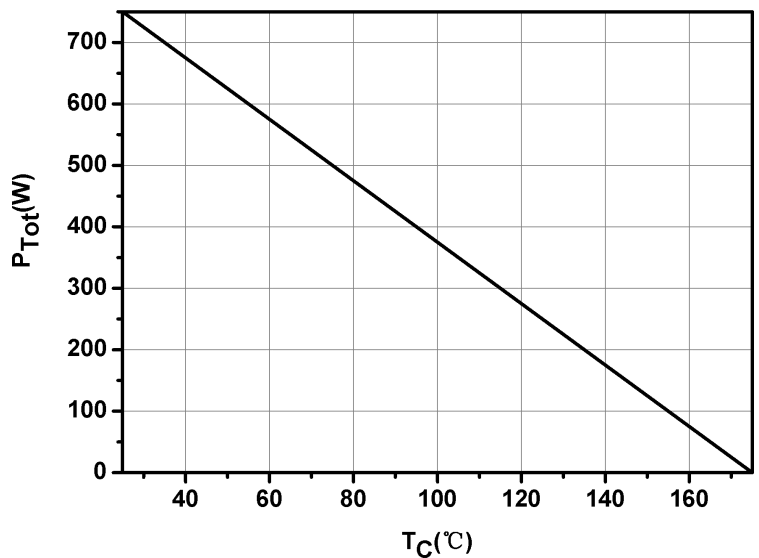
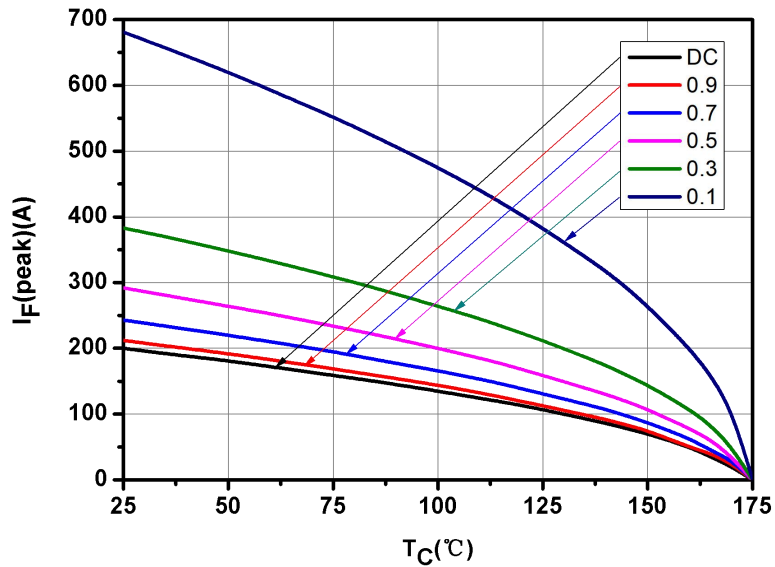
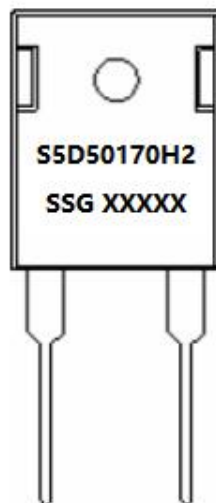


Fig.6-Power Derating



**Fig.7-Current Derating**

## Marking Diagram

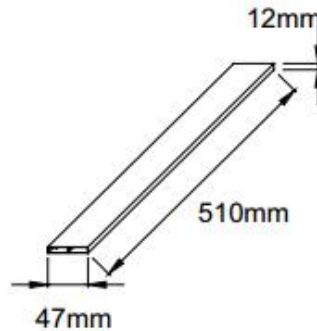


Where XXXXX is YYWWL

S5D = Device Type  
H = Package type  
50 = Forward Current (50A)  
170 = Reverse Voltage (1700V)  
SSG = SSG  
YY = Year  
WW = Week  
L = Lot Number

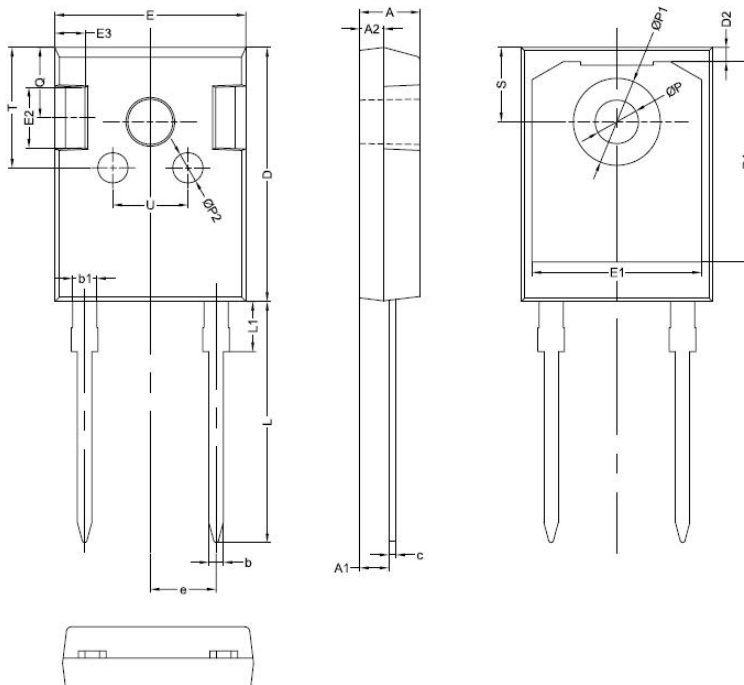
**Cautions:** Molding resin  
Epoxy resin UL:94V-0

## Tube Specification



TO-247AC(TO-247-2)

## Mechanical Dimensions TO-247AC(TO-247-2)



SYMBOL	Millimeters		
	MIN.	TYP.	MAX.
A	4.80	5.00	5.20
A1	2.20	2.41	2.61
A2	1.90	2.00	2.10
b	1.10	1.20	1.35
b1	1.80	2.00	2.20
c	0.50	0.60	0.75
D	20.30	21.00	21.20
D1		16.58	
D2		1.17	
E	15.60	15.80	16.00
E1		14.02	
E2		5.00	
E3		2.50	
e		5.44	
L	19.42	19.92	20.42
L1		4.13	
P	3.50	3.60	3.70
P1	7.1	7.19	7.40
P2		2.50	
Q		5.80	
S	6.05	6.15	6.25
T		10.00	
U		6.20	

**Technical Data**  
**Data Sheet N2889, REV.-**



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